

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS2290	Mar-96	9604 K	DALLAS	DA073370	PCB	SIPSTIK

STRESS/JOB NO.

READPOINT
(Sample Size/No. of Fails)

Hi Temp Storage 85°C, No Bias P-17082	<u>336 Hr</u> 11/0	<u>1000 Hr</u> 11/0	<u>Cum %</u> 0.0%
Temp Cycle -40°C to +85°C P-17083	<u>100 ~</u> 11/0	<u>500 ~</u> 11/0	<u>Cum %</u> 0.0%
Moisture Soak 60°C / 90% R.H. P-17084	<u>192 Hr</u> 11/0	<u>384 Hr</u> 11/0	<u>Cum %</u> 0.0%

Failure Mode

Failure Analysis